



NEWS RELEASE

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FOR IMMEDIATE RELEASE

PHOTO STENCIL'S VICE PRESIDENT OF TECHNOLOGY RECEIVES LEADERSHIP AWARD

Dr. Bill Coleman recognized by the IPC



Dr. Bill Coleman accepting the IPC Award

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COLORADO SPRINGS, Colorado – April 9, 2007 – Photo Stencil, the leading provider of premium stencils and additional high-end tooling for the SMT assembly industry, announces that

Committee Leadership award by the IPC Association Connecting Electronics Industries.

This award recognizes his leadership of IPC Task Group 5-21e. It was presented to Coleman at the IPC awards luncheon on Monday, February 19 at the Los Angeles Convention Center.

“Working with the task group allows me to help find solutions for the problems our customers face every day at Photo Stencil and throughout the industry,” says Coleman.

Coleman led the group in developing Revision A to IPC-7525 Stencil Design Guidelines. The guidelines address a number of issues, including lead-free printing processes. The proposed changes include refined aperture configurations and area ratios, as well as new guidelines for printing adhesives.

“We are very proud of Bill,” says Larry Heitz, president of Photo Stencil. “He has been an integral part of our service and product development, as well as an important member of the SMT industry for a long time. He deserves this recognition.”

At Photo Stencil for over 18 years, Coleman has spent significant time researching, developing and patenting solutions for the SMT industry. To download technical papers authored by Dr. Coleman, please visit www.photostencil.com/techpapers.htm.

IPC

IPC (www.ipc.org) is a global trade association based in Bannockburn, Ill., dedicated to the competitive excellence and financial success of its 2,400 member companies which represent all facets of the electronics interconnect industry, including design, printed circuit board manufacturing and electronics assembly. As a member-driven organization and leading source for industry standards, training, market research and public policy advocacy, IPC supports programs to meet the needs of an estimated \$1.5 trillion global electronics industry. IPC maintains additional offices in Taos, N.M.; Arlington, Va.; Garden Grove, Calif.; Stockholm, Sweden; and Shanghai, China.

Photo Stencil

Photo Stencil is a full-service provider of high-performance stencils and tooling for the surface mount technology (SMT) assembly industry. Photo Stencil's technology includes the patented AMTX E-FAB® electroformed stencils, the new high-performance proprietary NicAlloy™ stencil, laser-cut stencils and chem-etch stencils. Step or multilevel stencils are available in all three of the stencil technologies. Stencil design support and customer specific design libraries are provided.

Other SMT tooling includes thick film and metal mask screens. Photo Stencil offers a complete line of squeegee blades, featuring the patented E-Blade® electroformed squeegee blade. Solder pallets, SMT process carriers and populated PCB inspection templates are also available.

Headquartered in Colorado Springs, Photo Stencil was founded in 1979 and currently holds many patents and trademarks, such as AMTX E-FAB electroformed stencils. The company has additional manufacturing facilities in Mexico and Malaysia. More information is available at www.photostencil.com.

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